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Power MOSFET

TO-220AB G G N-Channel MOSFET

PRODUCT SUMMARY					
V _{DS} (V)	600				
R _{DS(on)} (Ω)	V _{GS} = 10 V 0.75				
Q _g max. (nC)	49				
Q _{gs} (nC)	13				
Q _{gd} (nC)	20				
Configuration	Single				

FEATURES

- Low gate charge Q_g results in simple drive requirement
 Improved gate avalanche and dynamic dV/dt ROHS³
- Improved gate, avalanche and dynamic dV/dt ruggedness
- Fully characterized capacitance and avalanche voltage and current
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

APPLICATIONS

- Switch mode power supply (SMPS)
- Uninterruptible power supply
- High speed power switching

APPLICABLE OFF LINE SMPS TOPOLOGIES

- Active clamped forward
- Main switch

ORDERING INFORMATION				
Package	TO-220AB			
Lead (Pb)-free	IRFB9N60APbF			
Lead (Pb)-free and halogen-free	IRFB9N60APbF-BE3			

ABSOLUTE MAXIMUM RATINGS (T _C	= 25 °C, unl	ess otherwis	se noted)		
PARAMETER			SYMBOL	LIMIT	UNIT
Drain-source voltage			V _{DS}	600	N
Gate-source voltage			V _{GS}	± 30	- V
Continuous ducin current	V _{GS} at 10 V	T _C = 25 °C	- I _D	9.2	
Continuous drain current		T _C = 100 °C		5.8	А
Pulsed drain current ^a			I _{DM}	37	
Linear derating factor				1.3	W/°C
Single pulse avalanche energy ^b			E _{AS}	290	mJ
Repetitive avalanche current ^a			I _{AR}	9.2	A
Repetitive avalanche energy ^a			E _{AR}	17	mJ
Maximum power dissipation	T _C =	25 °C	PD	170	W
Peak diode recovery dV/dt ^c			dV/dt	5.0	V/ns
Operating junction and storage temperature range		T _J , T _{stg}	-55 to +150	- °C	
Soldering recommendations (peak temperature) ^d	For 10 s		-	300	
Mounting torque	6-32 or M3 screw			10	lbf · in
Mounting torque				1.1	N·m

Notes

- a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11)
- b. Starting $T_J = 25$ °C, L = 6.8 mH, $R_g = 25 \Omega$, $I_{AS} = 9.2$ A (see fig. 12)
- c. $I_{SD} \le 9.2$ Å, dl/dt ≤ 50 Å/µs, $V_{DD} \le V_{DS}$, $T_J \le 150$ °C
- d. 1.6 mm from case



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THERMAL RESISTANCE RAT	NGS									
PARAMETER	SYMBOL	TYP		MAX.			UNIT			
Maximum junction-to-ambient	R _{thJA}	-		62						
Case-to-sink, flat, greased surface	R _{thCS}	0.50)	-		°C/W				
Maximum junction-to-case (drain)	R _{thJC}	-		0.75		1				
	•									
SPECIFICATIONS ($T_J = 25 \ ^{\circ}C$, u	unless otherw	vise noted)								
PARAMETER	SYMBOL		T CONDITIONS	м	IN. T)	′P.	MAX.	UNIT		
Static					<u> </u>			Į		
Drain-source breakdown voltage	V _{DS}	V _{GS}	= 0 V, I _D = 250 μA	6	00	-	-	V		
V _{DS} temperature coefficient	$\Delta V_{DS}/T_{J}$		ce to 25 °C, I _D = 1 m/	Ą	- 60	60	-	mV/°C		
Gate-source threshold voltage	V _{GS(th)}		= V _{GS} , I _D = 250 μA		.0	-	4.0	V		
Gate-source leakage	I _{GSS}		V _{GS} = ± 30 V			-	± 100	nA		
Zerren al en elle en desta en en el		V _{DS} =	= 600 V, V _{GS} = 0 V			-	25	•		
Zero gate voltage drain current	IDSS	V _{DS} = 480 V	/, V _{GS} = 0 V, T _J = 128	5 °C		-	250	μA		
Drain-source on-state resistance	R _{DS(on)}	V _{GS} = 10 V	I _D = 5.5 A ^b			-	0.75	Ω		
Forward transconductance	9 _{fs}	V _{DS}	= 50 V, I _D = 5.5 A	5	.5	-	-	S		
Dynamic		•		÷	•	·		•		
Input capacitance	C _{iss}		$V_{CS} = 0 V_{c}$		- 14	00	-			
Output capacitance	C _{oss}	V _{GS} = 0 V, V _{DS} = 25 V, f = 1.0 MHz, see fig. 5			- 18	30	-			
Reverse transfer capacitance	C _{rss}				- 7	.1	-			
Output capacitance	C _{oss}		V _{DS} = 1.0 V, f = 1.	0 MHz	- 19	57	-	pF		
Output capacitance		$V_{GS} = 0 V$	V _{DS} = 480 V, f = 1.	0 MHz	- 4	9	-			
Effective output capacitance	C _{oss} eff.		V _{DS} = 0 V to 48	60 V	- 9	6	-			
Total gate charge	Qg				-	-	49			
Gate-source charge	Q _{gs}	V _{GS} = 10 V	$I_D = 9.2 \text{ A}, V_{DS} = 0.2 \text{ see fig. 6 and 1}$		-	-	13	nC		
Gate-drain charge	Q _{gd}				-	-	20			
Turn-on delay time	t _{d(on)}		•		- 1	3	-			
Rise time	t _r	V _{DD} =	= 300 V, I _D = 9.2 A		- 2	5	-			
Turn-off delay time	t _{d(off)}		$R_D = 35.5 \Omega$, see fig.	10 ^b	- 3	0	-	ns		
Fall time	t _f	1			- 2	2	-			
Gate input resistance	R _g	f = 1 MHz, open drain		0	.5	-	3.2	Ω		
Drain-Source Body Diode Characteristi	cs									
Continuous source-drain diode current	۱ _S	MOSFET symbol		-	9.2	A				
Pulsed diode forward current ^a	I _{SM}	integral revers p - n junction		↓ s	-	-	37			
Body diode voltage	V _{SD}	T _J = 25 °C	$I_{\rm S}$ = 9.2 A, $V_{\rm GS}$ = 0	Vb		-	1.5	V		
Body diode reverse recovery time	t _{rr}	T 25 °C I	= 9.2 A, dl/dt = 100		- 53	30	800	ns		
Body diode reverse recovery charge	Q _{rr}	$1 = 23 \text{ C}, \text{I}_{\text{F}}$	= 3.2 A, ul/ut = 100	rvµs~	- 3	.0	4.4	μC		
Forward turn-on time	t _{on}	Intrinsic tu	ırn-on time is negligi	ble (turn-on i	s dominat	ed by	y L _S and L _D)			

Notes

a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11)

b. Pulse width \leq 300 µs; duty cycle \leq 2 %

c. C_{oss} effective is a fixed capacitance that gives the same charging time as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DS}

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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

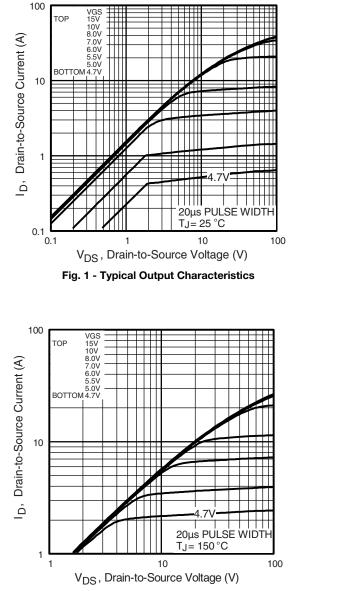


Fig. 2 - Typical Output Characteristics

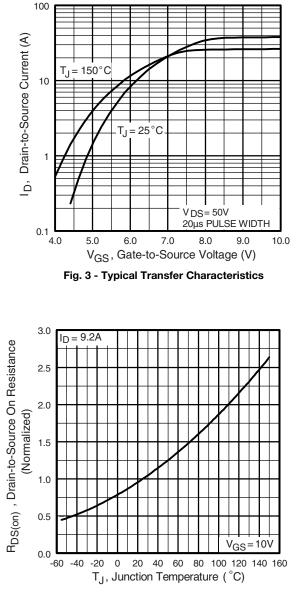


Fig. 4 - Normalized On-Resistance vs. Temperature



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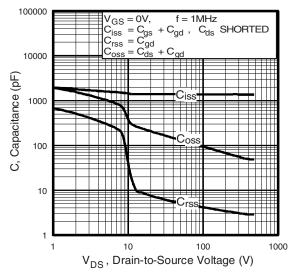


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

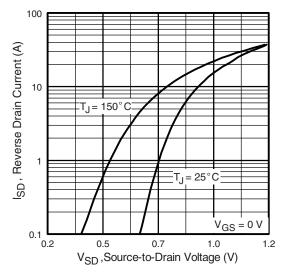


Fig. 7 - Typical Source-Drain Diode Forward Voltage

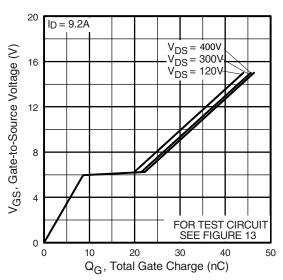


Fig. 6 - Typical Gate Charge vs. Gate-to-Source Voltage

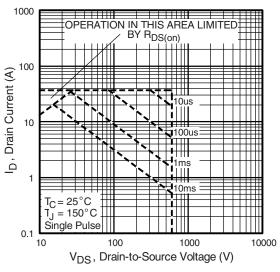


Fig. 8 - Maximum Safe Operating Area



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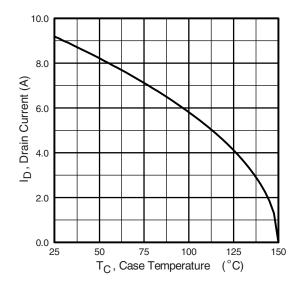


Fig. 9 - Maximum Drain Current vs. Case Temperature

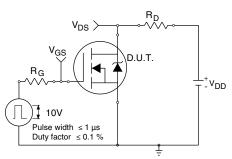


Fig. 10a - Switching Time Test Circuit

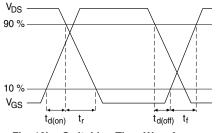


Fig. 10b - Switching Time Waveforms

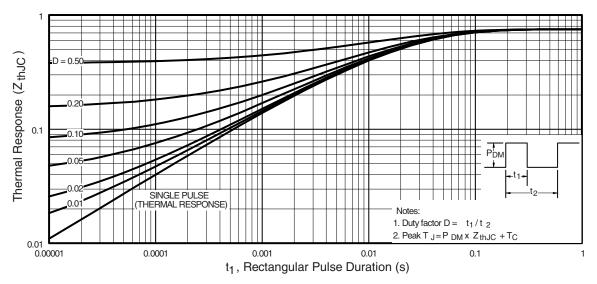


Fig. 11 - Maximum Effective Transient Thermal Impedance, Junction-to-Case

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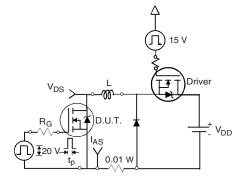
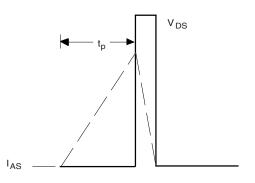


Fig. 12a - Unclamped Inductive Test Circuit



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Fig. 12b - Unclamped Inductive Waveforms

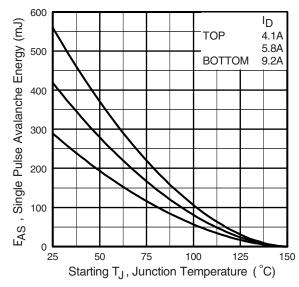
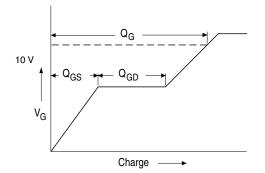


Fig. 12c - Maximum Avalanche Energy vs. Drain Current





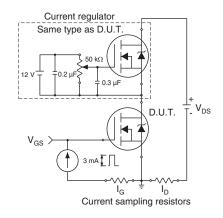


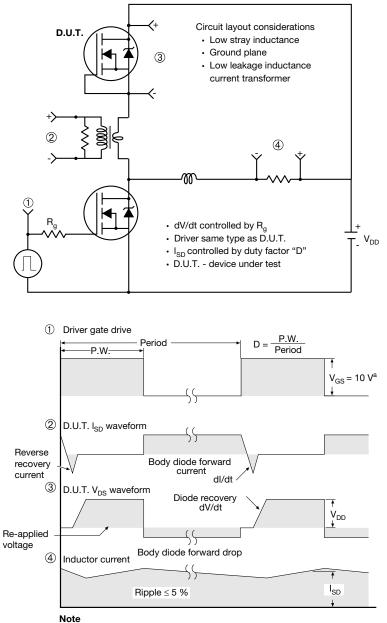
Fig. 13b - Gate Charge Test Circuit

6 For technical questions, contact: <u>hvm@vishay.com</u>



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Peak Diode Recovery dV/dt Test Circuit



a. $V_{GS} = 5 V$ for logic level devices

Fig. 14 - For N-Channel

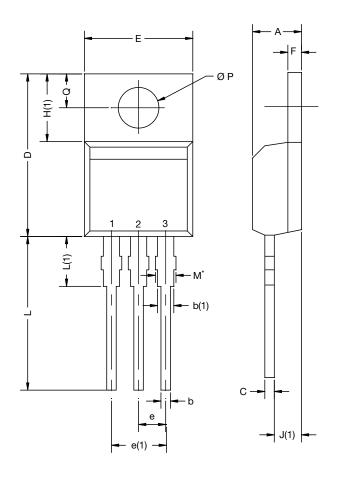
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TO-220-1



DIM	MILLIN	METERS	INC	HES
DIM.	MIN.	MAX.	MIN.	MAX.
А	4.24	4.65	0.167	0.183
b	0.69	1.02	0.027	0.040
b(1)	1.14	1.78	0.045	0.070
С	0.36	0.61	0.014	0.024
D	14.33	15.85	0.564	0.624
E	9.96	10.52	0.392	0.414
е	2.41	2.67	0.095	0.105
e(1)	4.88	5.28	0.192	0.208
F	1.14	1.40	0.045	0.055
H(1)	6.10	6.71	0.240	0.264
J(1)	2.41	2.92	0.095	0.115
L	13.36	14.40	0.526	0.567
L(1)	3.33	4.04	0.131	0.159
ØP	3.53	3.94	0.139	0.155
Q	2.54	3.00	0.100	0.118

Note

• M* = 0.052 inches to 0.064 inches (dimension including protrusion), heatsink hole for HVM

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